Silicon NPN Epitaxial

HITACHI

Application

Low frequency amplifier, switching

Outline

MPAK

3
1. Emitter
2. Base
3. Collector



Absolute Maximum Ratings ($Ta = 25^{\circ}C$)

Item	Symbol	Ratings	Unit	
Collector to base voltage	V_{CBO}	120	V	
Collector to emitter voltage	V_{CEO}	120	V	
Emitter to base voltage	V_{EBO}	5	V	
Collector current	I _c	100	mA	
Collector power dissipation	P _c	150	mW	
Junction temperature	Tj	150	°C	
Storage temperature	Tstg	-55 to +150	°C	

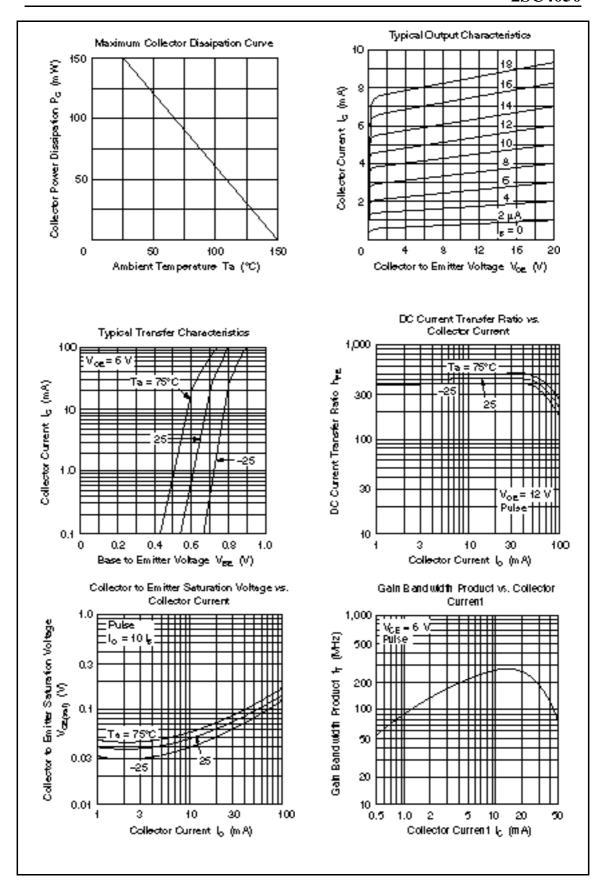
Electrical Characteristics ($Ta = 25^{\circ}C$)

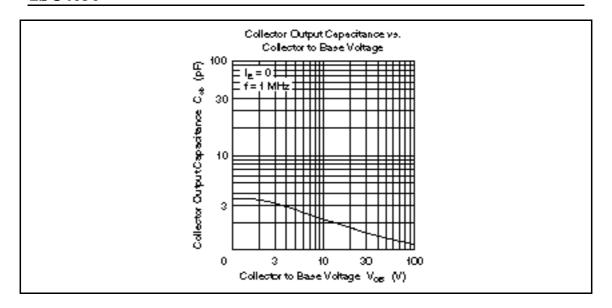
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	120	_	_	V	$I_{c} = 10 \ \mu A, \ I_{E} = 0$
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	120	_	_	V	$I_C = 1 \text{ mA}, R_{BE} =$
Emitter to base breakdown voltage	$V_{\text{(BR)EBO}}$	5	_	_	V	$I_{E} = 10 \ \mu A, \ I_{C} = 0$
Collector cutoff current	I _{CBO}	_	_	0.1	μΑ	$V_{CB} = 70 \text{ V}, I_{E} = 0$
Emitter cutoff current	I _{EBO}	_	_	0.1	μΑ	$V_{EB} = 2 \text{ V}, I_{C} = 0$
DC current transfer ratio	h _{FE} *1	250	_	800		$V_{CE} = 12 \text{ V}, I_{C} = 2 \text{ mA}^{*2}$
Collector to emitter saturation voltage	$V_{\text{CE(sat)}}$	_	_	0.1	V	$I_{\rm C} = 10 \text{ mA}, I_{\rm B} = 1 \text{ mA}^{*2}$
Base to emitter saturation voltage	$V_{BE(sat)}$	_	_	1.1	V	$I_{\rm C} = 10 \text{ mA}, I_{\rm B} = 1 \text{ mA}^{*2}$

Notes: 1. The 2SC4050 is grouped by h_{FE} as follows.

2. Pluse test

Grade	D	E
Mark	KID	KIE
h _{FE}	250 to 500	400 to 800





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